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REMARKS

Claims 10-28 are pending in this application. By this Preliminary Amendment, Applicants AMEND the title of the invention, the specification, and the abstract of the disclosure, CANCEL claims 1-9 and ADD new claims 10-28.

Applicants have attached hereto a Substitute Specification in order to make corrections of minor informalities contained in the originally filed specification. Applicants' undersigned representative hereby declares and states that the Substitute Specification filed concurrently herewith does not add any new matter whatsoever to the Accordingly, entry and consideration of the above-identified patent application. Substitute Specification are respectfully requested.

The changes to the specification have been made to correct minor informalities to facilitate examination of the present application.

Applicants respectfully submit that this application is in condition for allowance. Favorable consideration and prompt allowance are respectfully solicited.

Respectfully submitted,

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### DESCRIPTION

ONE-PORT SURFACE ACOUSTIC WAVE RESONATOR AND SURFACE ACOUSTIC WAVE
FILTER

# BACKGROUND OF THE INVENTION

# 1. Technical Field of the Invention

\_\_\_\_\_\_The present invention relates to one-port surface acoustic wave resonators having reflectors disposed on at both sides of an interdigital electrode transducer and relates to surface acoustic wave filters includingusing the one-port surface acoustic wave resonators. More specifically, the present invention relates to one-port surface acoustic wave resonators and surface acoustic wave filters which include use a rotated Y-cut LiTaO<sub>3</sub> substrate as a piezoelectric substrate.

# 2. Description of the RelatedBackground Art

including using—a rotated Y-cut X-propagation LiTaO<sub>3</sub> substrate have heretofore—been proposed for use as to constitute—bandpass filters for communication devices. A The—one-port surface acoustic wave resonator includes an interdigital electrode transducer and reflectors disposed on at—both sides in the surface acoustic wave propagation direction of the interdigital electrode transducer on a LiTaO<sub>3</sub> substrate. A surface acoustic wave filter using the one-port surface acoustic wave resonator must is required to—have small fluctuations fluctuation—of frequency characteristics.

[0003] Japanese Unexamined Patent Application Publication No. 7
283682 (—Patent Document 1) mentioned below discloses that good

characteristics of one-port surface acoustic wave resonators using the

above-mentioned Y-cut X-propagation LiTaO<sub>3</sub> substrate can be obtained by maintaining the controlling-the-ratio  $(h/\lambda)$  of an electrode film thickness (h) to a wavelength  $(\lambda)$  of the surface acoustic wave to the range of 0.06 to 0.10 and by maintainingcontrolling the metallization ratio of the electrode to 0.6 or less.

[0004] Japanese Unexamined Patent Application Publication No. 993072 (—Patent Document 2)—mentioned below discloses that a yield of ladder-type surface acoustic wave filters having a plurality of oneport surface acoustic wave resonators can be improved by

maintainingeontrolling the metallization ratio of the electrode atto

0.6 or more, and preferably, in to—the range of 0.6 to 0.8.

The ladder-type surface acoustic wave filter having a plurality of one-port surface acoustic wave resonators is commonlygenerally used in duplexers as a low-frequency bandpass filter. The ladder-type surface acoustic wave filter of the low-frequency bandpass filter must is required to have steep cut-off characteristics at the blocking band onef the higher frequency side of the pass band. Therefore, in order to increase the cut-off steepness, the Q-factor of an antiresonance frequency must is required to be improved in the one-port surface acoustic wave resonators definingeonstituting a serial arm resonator of a ladder circuit.

\_\_\_\_Additionally, it is known that the one-port surface acoustic wave resonator is serially connected to a surface acoustic wave filter in order to sufficiently increase the attenuation level at a specific certain frequency in the outside of the pass band of the surface acoustic wave filter. Here, a trap is provided constituted at the antiresonance frequency of the one-port surface acoustic wave resonator. With this In such a structure, the Q-factor of the antiresonance frequency of the one-port surface acoustic wave resonator must is also required to be improved.

[0007] U.S. Patent No. 6,556,104 (—Patent Document 3) mentioned

below discloses that the Q-factor of the antiresonance frequency can be improved by <u>settingeontrolling</u> the cut angle of a rotated Y-cut X-propagation LiTaO<sub>3</sub> substrate to 46° or more in the one-port surface acoustic wave resonator using the LiTaO<sub>3</sub> substrate.

[0008] T. Matsuda, J. Tsutsumi, S. Inoue, Y. Iwamoto, Y. Satoh,
"High-Frequency SAW Duplexer with Low-Loss and Steep Cut-Off

Characteristics" IEEE International Ultrasonics Symposium, Oct. 8-11,

2002 (—Non-Patent Document 1)—mentioned below discloses that the Qfactor of the antiresonance frequency is increased by controlling the
metallization ratio to be less than 0.4 in the one-port surface
acoustic wave resonator using a 36° to 42°-rotated Y-cut X-propagation

LiTaO3 substrate.

Patent Document 1: Japanese Unexamined Patent Application Publication
No. 7-283682

Patent Document 2: Japanese Unexamined Patent Application Publication
No. 9-93072

Patent Document 3: US Patent No. 6,556,104

Non Patent Document 1: T. Matsuda, J. Tsutsumi, S. Inoue, Y. Iwamoto,
Y. Satoh, "High Frequency SAW Duplexer with Low Loss and Steep Cut Off
Characteristics" IEEE International Ultrasonics Symposium, Oct. 8-11,
2002

### Disclosure of Invention

[0009] ——In a one-port surface acoustic wave resonator using a rotated Y-cut X-propagation LiTaO<sub>3</sub> substrate, the dependency of the acoustic velocity on the metallization ratio is the lowest at a metallization ratio of about 0.75. SpecificallyNamely, when the metallization ratio is about 0.75, the frequency fluctuation caused by a fluctuation in the precision of electrode formation is the lowest. Therefore, as described in the Patent Documents 1 and 2, it is

recognized that a metallization ratio of 0.6 or more is preferable for decreasing the frequency fluctuation and  $\underline{\text{for}}$  improving the yield.

\_\_\_\_\_According to the\_Patent Document 3, in the one-port surface acoustic wave resonator using a rotated Y-cut X-propagation LiTaO3 substrate, the Q-factor of the antiresonance frequency can be improved by using a the\_LiTaO3 substrate having a cut angle of 46° or more. However, the Q-factor of the antiresonance frequency is—sharply deteriorates as the deteriorated with an increase in the metallization ratio of the electrodes increaseselectrode, even whenif the one-port surface acoustic wave resonator includingusing a 46° to 50°-rotated Y-cut LiTaO3 substrate is usedprepared; which is a problem.

[0011] ——According to the Non-Patent Document 1, an improveda favorable Q-factor of the antiresonance frequency is achieved by decreasing the metallization ratio to be 0.4 or less.

resonator using a Y-cut X-propagation LiTaO<sub>3</sub> substrate, the metallization ratio of the electrode must be increased to 0.5 or more in order to decrease the frequency fluctuation. On the other hand, a metallizationduty ratio must be decreased to 0.4 or less in order to improve the Q-factor of the antiresonance frequency. Thus, it is very difficult to simultaneously improvesimultaneous realization of both the improvement of the Q-factor of the antiresonance frequency and the improvement of the frequency fluctuation—is very difficult.

# SUMMARY OF THE INVENTION

embodiments of the — The present invention has been accomplished under such circumstances of the above-mentioned conventional technology, and an object of the present invention is to provide a one-port surface acoustic wave resonator having a Y-cut X-propagation LiTaO3 substrate whichand being able to simultaneously achieves realize

both <u>an the</u>-improvement of the Q-factor of the antiresonance frequency and <u>a the</u>-decrease of the frequency fluctuation, and <del>to</del>-provide a surface acoustic wave filter <u>includingusing</u> the one-port surface acoustic wave resonator.

The one-port surface acoustic wave resonator according to a preferred embodiment aspect of the present invention includes a rotated Y-cut LiTaO3 substrate, an interdigital electrode transducer provided on the LiTaO3 substrate, and reflectors disposed at both sides of the interdigital electrode transducer in the surface acoustic wave propagation direction of the interdigital electrode transducer. When the electrode finger width of the interdigital electrode fingers is denoted by a and the gap between the electrode fingers is denoted by b, the metallization ratio, a/(a + b), is in the range of about 0.55 to about 0.85 and the interdigital electrode transducer is assigned with overlapping-length weighted.

According to another preferred embodiment of —— In the present invention, the above-mentioned LiTaO3 substrate preferably has a cut angle of about 36° to about 60°. In the one-port surface acoustic wave resonator including a rotated Y-cut LiTaO3 substrate, an interdigital electrode transducer provided on the LiTaO3 substrate, and reflectors disposed at both sides of the interdigital electrode transducer in the surface acoustic wave propagation direction of the interdigital electrode transducer, the metallization ratio, a/(a + b), is in the range of about 0.45 to about 0.85 when the electrode finger width of the interdigital electrode transducer is denoted by a and the gap between the electrode fingers is denoted by b, the interdigital electrode transducer is weightedassigned with weight, and the cut angle of the LiTaO3 substrate is in the range of about 40° to about 60°. Additionally, in the one-port surface acoustic wave resonator according to a preferred embodimentspecific aspect of the present invention, the amount of the overlapping-length weighting is about

87.5% or less, preferably about 75% or less.

[0016] ——In the one-port surface acoustic wave resonator according to another preferred embodimentspecific aspect of the present invention, the film thickness of the interdigital electrode transducer is set such controlled so that the mass is equivalent to that of an aluminum electrode having a film thickness of about 8% to about 14% of the wavelength of the surface acoustic wave, preferably about 8.5% to about 11.5%, and more preferably about 9% to about 11%. [0017] ——In the one-port surface acoustic wave resonator according to another preferred embodimentspecific aspect of the present invention, the film thickness of the interdigital electrode transducer is set such controlled so that the mass is equivalent to that of a copper electrode having a film thickness of about 2.4% to about 4.2% of the wavelength of the surface acoustic wave. [0018] ——In the one-port surface acoustic wave resonator according to another preferred embodimentspecific aspect of the present invention, the film thickness of the interdigital electrode transducer is set such<del>controlled so</del> that the mass is equivalent to that of a gold electrode having a film thickness of about 1.1%.1 to about 2.0% of the wavelength of the surface acoustic wave. [0019] ——The surface acoustic wave filter according to another preferred embodiment of the present invention includes is constituted by using the one-port surface acoustic wave resonator according to preferred embodiments of the present invention. Examples of the surface acoustic wave filter include, but are not limited to, a ladder-type surface acoustic wave filter, a lattice-type surface acoustic wave filter, and a surface acoustic wave filter having a one-

[0020] ——In the one-port surface acoustic wave resonator according to another preferred embodiment of the present invention, an interdigital electrode transducer and a pair of reflectors are

port surface acoustic wave resonator as a trap.

disposed on a rotated Y-cut LiTaO, substrate and the metallization ratio of the interdigital electrode transducer and the pair of reflectors is in the range of about 0.55 to about 0.85. Consequently, the frequency fluctuation is can be effectively decreased. Additionally, since the interdigital electrode transducer is assigned with-overlapping-length weighted, not only is the frequency fluctuation can be decreased, but also the Q-factor of the antiresonance frequency is also can be effectively increased. Previously, in a — Namely, in the one-port surface acoustic wave resonator, it has been very difficult to simultaneously achieve both a decrease in the frequency fluctuation and an improvement in the Q-factor of the antiresonance frequency. However, according to preferred embodiments of the present invention, the decrease in the frequency fluctuation and the improvement in the Q-factor of the antiresonance frequency arecan be simultaneously achieved by maintaining<del>controlling</del> the metallization ratio of the electrode in the above-mentioned particular range and assigning-overlapping-length weightingweight to the interdigital electrode transducer. [0022] ——Therefore, the cut-off steepness in the filter characteristics from the pass band to the blocking band is can be increased and the control of the trap using the one-port surface acoustic wave resonator is<del>ean be</del> effectively improved in<del>by</del> constituting various surface acoustic wave filters which includeusing the one-port surface acoustic wave resonator according to preferred

[0023] ——In particular, when the cut angle of the LiTaO<sub>3</sub> substrate is in the range of <u>about 36°</u> to <u>about 60°</u>, the Q-factor of the antiresonance frequency <u>isean be</u> effectively improved. In the one-port surface acoustic wave resonator including a rotated Y-cut LiTaO<sub>3</sub> substrate, an interdigital electrode transducer <u>provided</u> on the LiTaO<sub>3</sub> substrate, and reflectors <u>disposed</u> at both sides of the

embodiments of the present invention.

interdigital electrode transducer in the surface acoustic wave propagation direction of the interdigital electrode transducer, the frequency fluctuation isean be effectively decreased by settingeontrolling the metallization ratio, a/(a + b)+, to the range of about 0.45 to about 0.85 when the electrode finger width of the interdigital electrode transducer is denoted by a and a gap between the electrode fingers is denoted by b, weighting assigning weight to the interdigital electrode transducer, and also settingeontrolling the cut angle of the LiTaO3 substrate to the range of about 40° to about 60°. Additionally, since the interdigital electrode transducer is applied with overlapping-length weighted, not only is the frequency fluctuation is decreased, but also the Q-factor of the antiresonance frequency is also can be effectively increased.

\_\_\_\_\_The Q-factor of the antiresonance frequency <u>iscan be</u> further effectively improved by <u>settingcontrolling</u> the amount of the overlapping-length weight to <u>about 87.5%</u> or less, <u>and more preferably</u> to about 75% or less.

\_\_\_\_\_\_When the electrode film thickness is set suchcontrolled so that the mass is equivalent to that of an aluminum electrode having a film thickness of about 8% to about 14% of the wavelength of the surface acoustic wave, the Q-factor of the antiresonance isean be further effectively improved.

[0026] ——Similarly, when the electrode film thickness is <u>set</u>

<u>sucheontrolled so</u> that the mass is equivalent to that of <u>a an</u> copper electrode having a film thickness of <u>about 2.4%</u> to <u>about 4.2%</u> of the wavelength of the surface acoustic wave, the Q-factor of the antiresonance frequency <u>isean be</u> further effectively improved.

\_\_\_\_Similarly, when the electrode film thickness is <u>set</u>
<u>sucheontrolled so</u> that the mass is equivalent to that of a gold
electrode having a film thickness of <u>about 1.1%.1</u> to <u>about 2.0%</u> of the
wavelength of the surface acoustic wave, the Q-factor of the

antiresonance frequency is can be further effectively improved.

The surface acoustic wave filter according to preferred embodiments of the present invention includes is constituted by using the one-port surface acoustic wave resonator according to preferred embodiments of the present invention. Therefore, therefore, the frequency fluctuation is abe decreased and the Q-factor of the antiresonance frequency of the one-port surface acoustic wave resonator is also improved. Consequently, cut-off steepness of the filter characteristics from the pass band to the blocking band of the surface acoustic wave filter is abe increased and the trap characteristics is abe effectively improved by using the one-port surface acoustic wave resonator as the trap.

[0029] These and other features, elements, characteristics and advantages of the present invention will become more apparent from the following detailed description of preferred embodiments of the present invention with reference to the attached drawings.

[0031] [FIG. 2] FIG. 2 is a graph showing the relationship between the metallization ratio of the electrode and resonance frequency in the one-port surface acoustic wave resonator having a normal-type interdigital electrode transducer in Example 1.

[0032] [FIG. 3]—FIG. 3 is a graph showing the relationship between the metallization ratio of the electrode and frequency fluctuation in the surface acoustic wave resonator having a normal-type interdigital electrode transducer in Example 1.

[0033] --- [FIG. 4] FIG. 4 is a graph showing the relationship

between the metallization ratios and the Q-factors of the antiresonance frequency in a comparative example of the one-port surface acoustic wave resonator having a normal-type interdigital electrode transducer and in three examples of the one-port surface acoustic wave resonator which are assigned with overlapping-length weight.

[0034] [FIG. 5] FIG. 5 is a graph schematically showing impedance-frequency characteristics and phase-frequency characteristics when the metallization ratio of the electrode is varied in the one-port surface acoustic wave resonator having a normal-type interdigital electrode transducer.

[0035] [FIG. 6]—FIG. 6 is a graph showing the relationship among the cut angle and the metallizationduty ratio of the LiTaO<sub>3</sub> substrate and the Q-factor of the antiresonance frequency, in the one-port surface acoustic wave resonator having a normal-type interdigital electrode transducer.

[0036] \_\_\_\_\_[FIG. 7] FIG. 7 is a graph showing the relationship between the metallization ratio of the electrode and the Q-factor of the antiresonance frequency in the one-port surface acoustic wave resonator having a normal-type interdigital electrode transducer.

[0037] — [FIG. 8]—FIG. 8 is a graph showing the relationship between the metallization ratio of the electrode and the Q-factor of the antiresonance frequency when an aluminum film is further deposited on the busbar of the one-port surface acoustic wave resonator having a normal-type interdigital electrode transducer.

[0038] — [FIG. 9]—FIG. 9 is a graph schematically showing impedance-frequency characteristics and phase-frequency characteristics in a comparative example of the one-port surface acoustic wave resonator having a normal-type interdigital electrode transducer and in three examples of the one-port surface acoustic wave resonator which are assigned with overlapping-length weighting at

amounts of about an amount of 67.5%, about 75%, or about 87.5%. [0039] — [FIG. 10] FIG. 10 is a graph showing the relationship between the aluminum-electrode film thickness and the Q-factor of the antiresonance frequency in an example of the one-port surface acoustic wave resonator having interdigital electrode transducer assigned with overlapping-length weighting. [0040] \_\_\_\_\_[FIG. 11] FIG. 11 is a graph showing the relationship between the cut angle of a LiTaO3an aluminum substrate and the Q-factor of the antiresonance frequency in an example of the one-port surface acoustic wave resonator having interdigital electrode transducer assigned with overlapping-length weighting. [0041] \_\_\_\_\_[FIG. 12] FIG. 12 is a plan view showing an electrode structure of a surface acoustic wave filter having a ladder circuit structure as an example of the surface acoustic wave filter according to a preferred embodiment of the present invention. [0042] — [FIG. 13] FIG. 13 is a plan view showing an electrode structure of a surface acoustic wave filter having a lattice circuit structure as another example of the surface acoustic wave filter according to a preferred embodiment of the present invention. [0043] \_\_\_\_\_[FIG. 14] FIG. 14 is a plan view showing an electrode structure of a surface acoustic wave filter having a trap as another example of the surface acoustic wave filter according to a preferred embodiment of the present invention. DETAILED DESCRIPTION OF PREFERRED EMBODIMENTS

# Preferred embodiments of the Reference Numerals 1 one-port surface acoustic wave resonator 2 LiTaO<sub>3</sub> substrate 3 interdigital electrode transducer

-- 3a electrode finger

4, 5 reflector

4a, 4b electrode finger

31 ladder type surface acoustic wave filter

41 lattice type surface acoustic wave filter

42 to 45 one port surface acoustic wave resonator

51 surface acoustic wave filter having a trap

52 surface acoustic wave filter portion

53 one port surface acoustic wave resonator

51, 52 serial arm resonator

# Best Mode for Carrying Out the Invention

P1 to P3 parallel arm resonator

[0044] The present invention will now be described clarified by specifically describing embodiments with reference to the drawings.

[0045] ——FIG. 1A(a) is a schematic plan view showing a one-port surface acoustic wave resonator according to a preferred an—embodiment of the present invention, and FIG. 1Bb is an enlarged view of a portion thereof. the substantial part. The one-port surface acoustic wave resonator 1 includes a rotated Y-cut X-propagation LiTaO3 substrate 2. The cut angle of the LiTaO3 substrate is preferably in the range of about 36° to about 60°.

An interdigital electrode transducer 3 °, as it is disposed on obvious from Examples mentioned below.

[0046] On the LiTaO<sub>3</sub> substrate, an interdigital electrode transducer 3 and reflectors 4 and 5 are disposed on at both sides of the interdigital electrode transducer 3 in the surface acoustic wave propagation direction of the interdigital electrode transducer 3—are disposed. The interdigital electrode transducer 3 and the reflectors 4 and 5 are preferably formed by depositing a metal material, such as aluminum or an aluminum-based alloy, on the LiTaO<sub>3</sub> substrate and then patterning the metal material.it. Metal materials other than aluminum

and the aluminum-based alloy <u>may can be</u> also <u>be</u> used as the metal material.

[0047] ——The interdigital electrode transducer 3 includes a plurality of interdigitated electrode fingers 3a-intercalating into each other. Each of the reflectors 4 and 5 preferably includeshas a plurality of electrode fingers 4a and 5a, respectively, and has a structure that both ends-are each connected to the other side. [0048] ——In the one-port surface acoustic wave resonator 1 according to this preferred embodiment, the interdigital electrode transducer 3 and the reflectors 4 and 5 have a metallization ratio, a/(a + b), of about 0.55 to about 0.85, and the interdigital electrode transducer 3 is assigned with overlapping-length weighted as shown in the drawing. As shown in FIG. 1B(b), the metallization ratio, a/(a + b)b), is a ratio of an electrode finger width a to the total of the electrode finger width a and a gap b between the electrode fingers, wherewhen the electrode finger width of the interdigital electrode transducer 3 is denoted by a and the gap between the electrode fingers is denoted by b.

the overlapping-length weighting of weight assigned to the interdigital electrode transducer 3 is conducted by determining the length of a plurality of the electrode fingers 3a in such a manner that the overlapping-length is the greatest longest at the center and is reduced toward the outside in the surface acoustic wave propagation direction. FIG. 1A(a) shows an example of the assignment of overlapping-length weighting. In FIG. 1A(a), the overlapping-length at both ends sides—in the surface acoustic wave propagation direction of the interdigital electrode transducer 3 is drawn in a very small as size—compared to with—the overlapping-length at the center, in order to clearly show the overlapping-length weight—is assigned. In preferred embodiments of the present invention, the overlapping-length

weightingfor assigning weight is preferably set suchdetermined so that the amount of the weightingassigned weight is preferably about 87.5% or less, and more preferably, about 75% or less. As a resultWith this, the Q-factor of the antiresonance frequency is can be effectively improved. As shown in FIG. 1(a) by broken lines in FIG. 1A, the areas at whichwhere the electrodes are removed for weightingassigning weight may be provided with dummy electrodes 6.

The amount of the overlapping-length weighting means the weight stands for the degree of the assignment of overlapping-length weighting. For example, when an envelope curve defined by joining the ends of the electrode fingers providing for the overlapping length is linear, as in the interdigital electrode transducer 3 shown in FIG.

1A(a), the amount of the overlapping-length weight is represented by (B/A) × 100 (%), where wherein A ismeans the maximum extent of the overlapping length at the center of the interdigital electrode transducer 3 and B ismeans the minimum extent of the overlapping length at both ends in the surface acoustic wave propagation direction of the interdigital electrode transducer 3.

[0051] In—The envelope curve is a virtual line providing for the outer edge of the overlapping-length area. For example, in the interdigital electrode transducer 3, the envelope curve is a line connectingjoining the ends of a plurality of the electrode fingers which are connected to each other at the same electric potential.

[0052] As described—As mentioned above, when the overlapping-length

Meighting is set such weight is assigned so that the envelope curve is linear, the amount of the overlapping-length weighting is represented by (B/A) × 100 (%). In preferred embodiments of the present invention, the overlapping-length weighting may be assigned such so that the envelope curve has a shape other than a line, such as a sine curve, other than a line. When the overlapping-length weighting is assigned in such a manner that the envelope curve has a shape other than a line,

the dimensions of the area at whichwhere the overlapping-length weighting is assigned is determined on the basis of the dimensions of an area at whichwhere the overlapping-length weighting wouldweight is supposed to be assigned if in such a manner that the envelope curve were is—linear. SpecificallyNamely, when the dimensions of the area at whichwhere the weighting is assigned in—such a manner—that the envelope curve has a shape other than a line is Y, the dimensions of the area at whichwhere the weighting wouldweight is supposed to be assigned ifin such a manner that the envelope curve has a line is Y and the—(B/A) × 100 (%) is Z; the amount of the overlapping-length weighting in the case that the envelope curve has the shape other than a line is assigned as can be—Z.

\_\_\_\_\_\_In the one-port surface acoustic wave resonator 1, the interdigital electrode transducer 3 and the reflectors 4 and 5 are formed on the LiTaO3 substrate suchin such a manner that the metallization ratio is in the range of about 0.45 to about 0.85.

Therefore, as will be apparent from the it is obvious from examples described below, the antiresonance frequency fluctuation caused by a fluctuation in the electrode precision is ean be effectively decreased.

[0054] \_\_\_\_\_Additionally, the Q-factor of the antiresonance frequency is ean be significantly improved becausesince the interdigital electrode transducer 3 is assigned with overlapping-length weighted. This will be described with reference to the following concrete examples.

### +Example 1+

[0055] ——Rotated Y-cut X-propagation LiTaO<sub>3</sub> substrates were prepared. A normal-type interdigital electrode transducer and a pair of reflectors were formed of with—aluminum on each of the LiTaO<sub>3</sub> substrates substrate—at various metallization ratios. Then, resonance frequencies were determined. FIG. 2 shows the results. The

wavelength of the interdigital electrode transducer 3 was adjusted to about 2  $\mu m$ . The target resonance frequency was a resonance frequency of <u>about 2 GHz</u>, and the electrode film thickness was <u>about 10</u>% of the wavelength. With reference to FIG. 2, it was confirmed that the resonance frequency varied <u>as with a change in the metallization ratio</u> of the interdigital electrode transducer and the reflectors <u>changed</u>. It was also observed that the resonance frequency was the lowest at a metallization ratio of about 0.7.

One-port surface acoustic wave resonators having various metallization ratios were prepared by the same manner as described in the above. Resonance frequency fluctuation was determined when the size fluctuation in the width direction of the electrode fingers was about  $\pm$  0.02  $\mu$ m. FIG. 3 shows the results.

\_\_\_\_\_\_The frequency fluctuation on the vertical axis in FIG. 3 is a ratio (ppm) of a difference between an actual value of the resonance frequency of the prepared surface acoustic wave resonator and a target resonance frequency of 2 GHz to the target resonance frequency of 2 GHz.

[0058] ——With reference to FIG. 3, it was observed that the frequency fluctuation was the lowest at a metallization ratio of about 0.7.

[0059] ——A frequency fluctuation of about 4,000 ppm or less is preferable where a for the use in which smaller frequency tolerance is required. With reference to FIG. 3, it was observed that the requirement could be satisfied by maintaining the controlling the metallization ratio in to—the range of about 0.55 to about 0.85.

[0060] ——The inventors confirmed that the preferable range of the metallization ratio shown in FIG. 3 is did—not dependent updepend—on the electrode film thickness, by comparingfrom the results of an experiment performed by—using aluminum electrodes having various film thicknesses.

# +Example 2+

[0061] A one——One-port surface acoustic wave resonator includedhaving a normal-type interdigital electrode transducer and a pair of reflectors which were prepared as described in Example 1. this example, the time, a-Y-cut X-propagation LiTaO3 substrate had a cut angle of about 46°, the wavelength was about 2  $\mu m$ , the film thickness of the interdigital electrode transducer and the reflectors was about were-10% of the wavelength, the number of electrode finger pairs of the interdigital electrode transducer was 125, the overlapping-length of the electrode fingers was about 32 µm, and the target resonance frequency was about 2 GHz. The metallization ratios of the one-port surface acoustic wave resonators were varied, and Qfactors of the antiresonance frequency were determined. The results are were-shown in FIG. 4 by a solid line C. FIG. 5 shows impedancefrequency characteristics and phase-frequency characteristics. [0062] As shown by —As it is obvious from the solid line C in FIG. 4 and the wave patterns in FIG. 5, in the area where the metallization ratio is greater higher than about 0.45, it is observed that the Qfactor of the antiresonance frequency is significantly decreased to about 800 or less. On the other hand, it is observed that the Qfactor is favorably about 800600 or greatermore when the metallization ratio is about 0.45 or less. This tendency is consistent agrees with the content described in the above-mentioned Non-Patent Document 1. [0063] ——Therefore, in view of the results of Example 1 and Example 2, it is observed that the frequency fluctuation exceeds about 7,000 ppm in the conventional one-port surface acoustic wave resonator, even if the metallization ratio is maintained to about controlled to 0.4 in order to obtain a good Q-factor of the antiresonance frequency. This frequency fluctuation is about 14 MHz if the resonance frequency is about 2 GHz. Therefore, this frequency fluctuation is a crucial

defect in a device, such as a mobile phone, having a narrow frequency difference of about 20 MHz between a transmission transmit band and a reception receive band. Additionally, it is also highly desirable required in other applications to decrease this such a large frequency fluctuation.

[0064] ——However, as it was confirmed in Examples 1 and 2, it has been very difficult to simultaneously achieve both a decrease in the frequency fluctuation and a good Q-factor of the antiresonance frequency.

# +Example 3+

[0065] As In a rotated Y cut X propagation LiTaO<sub>3</sub> substrate, as described in the above-mentioned Patent Document 3, the Q-factor of the antiresonance frequency can be improved by maintaining controlling the cut angle of the LiTaO3 substrate in the range of about 46° to about 54°. TwoThen, two types of one-port surface acoustic wave resonators having a metallization ratio of about 0.4 and about or 0.6 were prepared by using Y-cut LiTaO3 substrates having various cut angles, as in Example 2. FIG. 6 shows the relationship between the cut angles of the LiTaO3 substrates in the resulting surface acoustic wave resonators and the Q-factors of the antiresonance frequency. [0066] ——As shown init is obvious from FIG. 6, when the metallization ratio was about 0.4, the Q-factor of the antiresonance frequency was greatly sharply improved by increasing with an increase in-the cut angle. On the other hand, when the metallization ratio was about 0.6, the Q-factor of the antiresonance frequency was not substantially hardly improved by increasing even if the cut angle was increased.

[0067] As shown in—As it is obvious from Example 3, the Q-factor of the antiresonance frequency cannot be improved because of the cut angle characteristics even if the metallization ratio is set to about

controlled to 0.6 for improving the frequency fluctuation.

# +Example 4+

factor of the antiresonance frequency is improved by decreasing the metallization ratio of electrodes. The cause of this <a href="improvement">improvement</a> is thought to be due to the waveguiding effect. <a href="SpecificallyNamely">SpecificallyNamely</a>, the acoustic velocity at the surface acoustic wave propagation <a href="portionpart">portionpart</a> of the interdigital electrode transducer is sufficiently faster than that at a busbar when the metallization ratio is small. Consequently, the locked-in effect of the interdigital electrode transducer as the waveguide is improved. Thus, <a href="image: item busbar to the outside">item busbar to the outside of the resonator is decreased <a href="maintended">so as to improve the Q-factor of the antiresonance frequency</a>.

Therefore, the inventors believe the above mentioned eause is correct, it is thought that the Q-factor may be improved by decreasing the acoustic velocity at the busbar instead of by increasing the acoustic velocity in the interdigital electrode transducer. Therefore, an aluminum film having a thickness of about 1 µm was deposited on only the busbar of each of the surface acoustic wave resonators having electrodes of various metallization ratios as in Example 2. FIG. 7 shows the relationship between the Q-factor of the antiresonance frequency and the metallization ratio of the surface acoustic wave resonator before the deposition of the second layer of the aluminum film having a thickness of about 1 µm on the busbar. The results shown in FIG. 7 are the same as the solid line C in the above-mentioned FIG. 4.

[0070] ——FIG. 8 shows the relationship between the Q-factor of the antiresonance frequency and the metallization ratio of the surface acoustic wave resonator after the deposition of the second layer of

the aluminum film on the busbar. As shown init is obvious by comparison of FIG. 7 and FIG. 8, it is observed that the Q-factor of the antiresonance frequency is not substantially hardly improved, even whenif the acoustic velocity of the busbar is reduced. Specifically, lowered. Namely, it is understood that the improvement of the Q-factor of the antiresonance frequency by controlling the relationship between the acoustic velocity at the busbar and the acoustic velocity at the interdigital electrode transducer is difficult.

# +Example 5+

not believeit is not thought that the main causes of the deterioration in the Q-factor of the antiresonance frequency when the metallization ratio is large are leakage components of the surface acoustic wave to the inside of the substrate and leakage components of the surface acoustic wave to the outside from the busbar. Furthermore, it was confirmed that the Q-factor of the antiresonance frequency was not improved by increasing the number of the reflector.

SpecificallyNamely, it is not thought that the cause is the leakage of the surface acoustic wave due to a shortage of reflectorsthe reflector.

[0072] ——The inventors have extensively studied and determinedfound that the Q-factor of the antiresonance frequency can be improved by weightingassigning weight, in particular, by assigning overlapping-length weighting weight to the interdigital electrode transducer 3.

[0073] ——In Example 5, the one-port surface acoustic wave resonators were prepared in the same manner as in Example 2 except that the interdigital electrode transducers were assigned with overlapping-length weighted. In this case, various types of the one-port surface acoustic wave resonators were prepared by varying the above-mentioned amounts of the overlapping-length weighting. The

metallization ratio of the electrodes was about 0.6.

The examples in which the amount of weighting is about the examples in which a normal-type interdigital electrode transducer is used and of three types of examples in which the amount of weighting is about the weight of 87.5%, about 75%, and about 67.5%.or 67.5% is assigned. In FIG. 9, the frequency characteristics of the various types of surface acoustic wave resonator characteristics of a comparative example in which a normal-type interdigital electrode transducer is used and of three types of examples in which the amount of weighting is about the weight of 87.5%, about 75%, and about 67.5%.or 67.5% is assigned. In FIG. 9, the frequency characteristics of the various types of surface acoustic wave resonators are slightly shifted to facilitate for ease of understanding thereof. Therefore, each characteristic is separately illustrated.

The Q-factors of the antiresonance frequency were determined by variously—changing the metallization ratio of electrodes in the plurality of one-port surface acoustic wave resonators having assigned with overlapping-length weighting. The results are shown in the above-mentioned FIG. 4 by solid lines O, X, and  $\Delta$ . In FIG. 4, O, X, and  $\Delta$  show the results when the amounts of the overlapping-length weighting were about 87.5%, about 75%, and about 67.5%, respectively.

ebserved that the Q-factor of the antiresonance frequency is greatlysharply improved by assigning overlapping-length weighting weight to the interdigital electrode transducer. Additionally, as shown init is obvious from FIG. 9, the resonance characteristics themselves were not substantiallylargely changed when interdigital electrode transducer included even if the above-mentioned overlapping-length weighting. weight was assigned. Therefore, it is understood that both the decrease in the frequency fluctuation and the improvement in Q-factor of the antiresonance are ean be simultaneously

achieved by assigning—overlapping-length weightingweight to the interdigital electrode transducer, even when if the metallization ratio was large, such as about 0.45 or more. In particular, the Q-factor of the antiresonance frequency and the frequency fluctuation are ean be effectively improved by overlapping-length weighting the interdigital electrode transducer, preferably with overlapping-length weighting of about 87.5% or less, and more preferably, with assigning overlapping-length weighting, preferably an overlapping length weight of about 75% or less, more preferably, 87.5% or less when the metallization ratio is in the range of about 0.55 to about 0.85, in which the frequency fluctuation can be effectively improved.

# +Example 6+

the metallization ratio is large, such as in the range of about 0.45 to about 0.85, the Q-factor of the antiresonance frequency isean be effectively improved by assigning overlapping-length weightingweight to the interdigital electrode transducer. NextThen, influences of the electrode film thickness on this effect were investigated. In the one-port surface acoustic wave resonators using a 48°-rotated LiTaO<sub>3</sub> substrate and including assigned with overlapping-length weightingweight at an amount of about 75%, improvement ratios (%) of the Q-factor of the antiresonance frequency were determined by varying the electrode film thickness. The metallization ratio was about 0.5.

\_\_\_\_\_As shown init is obvious from FIG. 10, it is observed that the Q-factor of the antiresonance frequency is ean be improved by the assigning overlapping-length weighting when the aluminum-electrode film thickness is in the range of about 8% to about 14% of a wavelength of the surface acoustic wave. In particular, the Q-factor is improved by about 50% or more when the aluminum-electrode film

thickness is in the range of <u>about 8.5%</u> to <u>about 11.5%</u> and is improved by <u>about 100%</u> or more when the electrode film thickness is in the range of about 9% to about 11%.

\_\_\_\_\_Therefore, in the present invention, the range of the electrode film thickness is preferably about 8% to about 14% of the wavelength, more preferably about 8.5% to about 11.5%, and most further preferably about 9% to about 11%, when the electrode is made of aluminum.

[0080] ——Furthermore, when the electrode is made of a metal material other than aluminum, such as copper or gold, or when the electrode is formed by laminating a plurality of metal materials, the similar results are effects could be obtained as long as the electrode has a thickness that is equivalent to the mass and the film thickness of the above-mentioned aluminum-electrode film thickness.

Specifically—Namely, an aluminum-electrode film thickness of about 8% to about 14% of the wavelength is equivalent to a copperelectrode film thickness of about 2.4% to about 4.2% of the wavelength and is equivalent to a gold-electrode film thickness of about 1.1% to about 2.0% of the wavelength. Similarly, an aluminum-electrode film thickness of about 8.5% to about 11.5% or about 9.0% to about 11.0% of the wavelength is equivalent to a copper-electrode film thickness of about 2.6% to about 3.5% or about 2.7% to about 3.3%, respectively, and is equivalent to a gold-electrode film thickness of about 1.2% to about 1.6% or about 1.3% to about 1.5%, respectively.

### +Example 7+

[0082] ——In Example 7, increase ratios of the Q-factor of the antiresonance frequency were determined by varying the cut angle of the LiTaO<sub>3</sub> substrate. The interdigital electrode transducers were the same as those in Example 6, and the aluminum-electrode film thickness was about 10% of the wavelength of the surface acoustic wave. FIG. 11

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shows the results.

[0083] ———As shown in<del>obvious from</del> FIG. 11, according to preferred embodiments of the present invention, the Q-factor of the antiresonance frequency is can be improved in all of the cut angles of the LiTaO3 substrate. In particular, when the cut angle is about 40° to about 60°, improvement effects on the Q-factor caused by using the interdigital electrode transducer includingassigned with overlappinglength weighting was about 100% or more as compared to with the case of using a normal-type interdigital electrode transducer. Furthermore, when the cut angle is about 44° to about 54°, the cut angle also improves the Q-factor of the antiresonance frequency. As a result, the Q-factor of the antiresonance frequency isean be further effectively improved with the Q-factor-improvement effect by the<del>assigning</del> overlapping-length weighting<del>weight to</del> the interdigital electrode transducer. Therefore, a metallization ratio of about 0.45 to about 0.85 and a cut angle of about 40° to about 60° are preferable. [0084] ——In the one-port surface acoustic wave resonator according to preferred embodiments of the present invention, both-the frequency fluctuation and the Q-factor of the antiresonance frequency are simultaneously improved by maintaining controlling the metallization ratio in to the range of about 0.45 to about 0.85, andmore preferably in the range of about 0.55 to about 0.85, and by using an interdigital electrode transducertransducer assigned with overlapping-length weighting. Therefore, the cut-off steepness of the filter characteristics is ean be effectively improved with a providingby constituting a surface acoustic wave filter includingusing the one-port surface acoustic wave resonator according to preferred embodiments of the present invention, and the or attenuation level of the blocking band of a surface acoustic wave filter isean be effectively improved by using the one-port surface acoustic wave resonator as a trap. Examples of the one-port surface acoustic wave

resonator according to <u>preferred embodiments of</u> the present invention and the surface acoustic wave filter using <u>the one-port surface</u> acoustic wave resonator <u>it</u> include, but <u>are not limited to</u>, <u>the surface acoustic wave filters shown in FIGs. 12 to 14.</u>

The surface acoustic wave filter shown in FIG. 12 is a ladder-type surface acoustic wave filter 31 and includes a plurality of serial arm resonators S1 and S2 and parallel arm resonators P1 to P3. The one-port surface acoustic wave resonator according to preferred embodiments of the present invention mayean be used as such a serial arm resonator or parallel arm resonator. In particular, the Q-factor of the antiresonance frequency in the serial arm resonators S1 and S2 can be improved by usingapplying the one-port surface acoustic wave resonator according to preferred embodiments of the present invention as to the serial arm resonators S1 and S2. With this, the cut-off steepness in the filter characteristics isean be increased at the higher frequency side of the pass band of the ladder-type surface acoustic wave filter 31.

\_\_\_\_\_\_The surface acoustic wave filter shown in FIG. 13 is a surface acoustic wave filter 41 <a href="having in-">having in-</a> a lattice circuit arrangement, and a plurality of one-port surface acoustic wave resonators 42 to 45 are connected to each other so as to <a href="havemake">havemake</a> grid connection. The one-port surface acoustic wave resonator according to <a href="preferred embodiments of the present invention is suitable for usecan be suitably used">preferred embodiments of the present invention is suitable for usecan be suitably used</a> as the one-port surface acoustic wave resonators 42 to 45.

[0087] ——FIG. 14 shows a surface acoustic wave filter 51 using a one-port surface acoustic wave resonator definingfor constituting a trap. In the surface acoustic wave filter 51, the one-port surface acoustic wave resonator 53 is connected with a surface acoustic wave filter portion 52 to defineconstitute the trap. Favorable trap characteristics are ean be obtained by using utilizing the

antiresonance frequency of the one-port surface acoustic wave resonator according to preferred embodiments of the present invention used as the one-port surface acoustic wave resonator 53.

invention has been described with respect to preferred embodiments thereof, it will be apparent to those skilled in the art that the disclosed invention may be modified in numerous ways and may assume many embodiments other than those specifically set out and described above.

Accordingly, it is intended by the appended claims to cover all modifications of the invention which fall within the true spirit and scope of the present invention.